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Renesas Electronics website: <http://www.renesas.com>

April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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PS7622A-2A
**8-PIN SOP, SLOW SWITCHING TYPE, 260 V BREAK DOWN VOLTAGE
2-ch Optical Coupled MOS FET**
DESCRIPTION

The PS7622A-2A is a solid state relay containing GaAs LEDs on the light emitting side (input side) and MOS FETs on the output side.

It is suitable for analog signal control because of its low offset and high linearity.

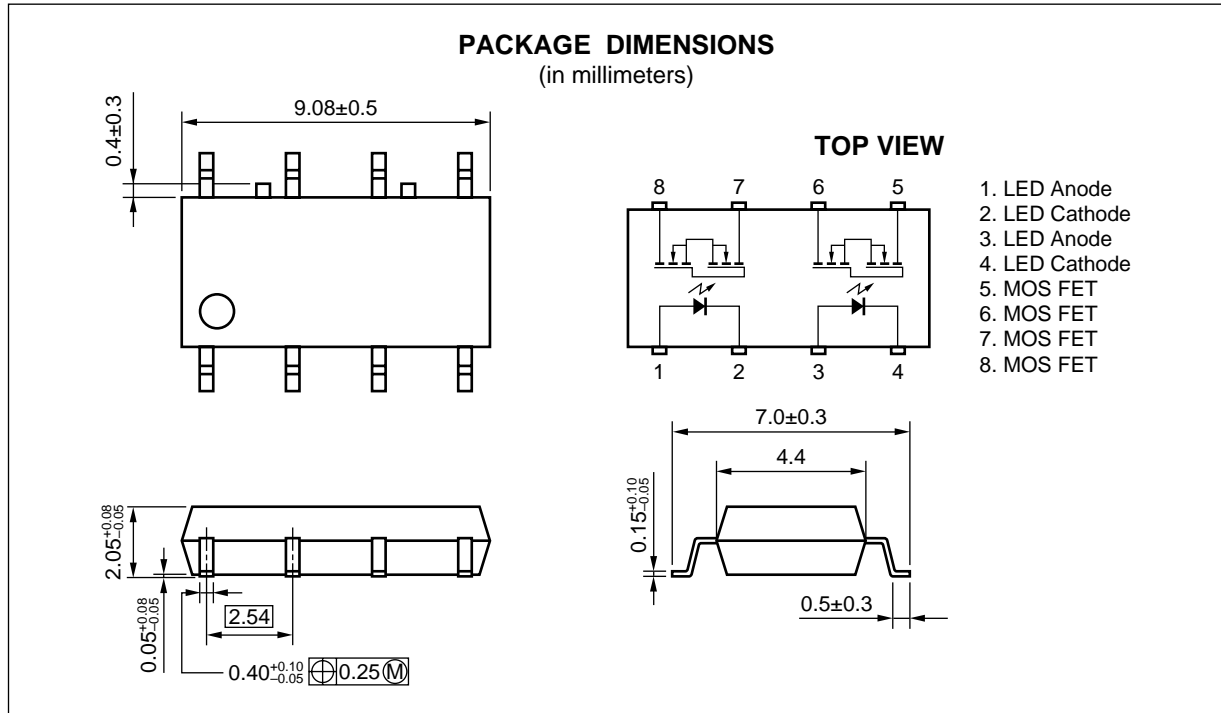
FEATURES

- 2 channel type (1 a + 1 a output)
- Low LED operating current ($I_f = 1 \text{ mA}$)
- Designed for AC/DC switching line changer
- Small and thin package (8-pin SOP, Height = 2.1 mm)
- Low offset voltage
- Ordering number of taping product: PS7622A-2A-F3, F4

APPLICATIONS

- Exchange equipment (FAX, MODEM, OCU + SLIC, etc.)
- Measurement equipment
- FA/OA equipment

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★ ORDERING INFORMATION

Part Number	Package	Packing Style	Application Part Number*1
PS7622A-2A	8-pin SOP	Magazine case 45 pcs	PS7622A-2A
PS7622A-2A -F3		Embossed Tape 1 500 pcs/reel	
PS7622A-2A -F4			

*1 For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	I _F	50	mA
	Reverse Voltage	V _R	5.0	V
	Power Dissipation	P _D	50	mW/ch
	Peak Forward Current ^{*1}	I _{FP}	1	A
MOS FET	Break Down Voltage	V _L	260	V
	Continuous Load Current	I _L	200	mA
	Pulse Load Current ^{*2} (AC/DC Connection)	I _{LP}	400	mA
	Power Dissipation	P _D	180	mW/ch
Isolation Voltage ^{*3}		BV	1 500	Vr.m.s.
Total Power Dissipation		P _T	460	mW
Operating Ambient Temperature		T _A	−40 to +80	°C
Storage Temperature		T _{stg}	−40 to +100	°C

*1 PW = 100 μs, Duty Cycle = 1 %

*2 PW = 100 ms, 1 shot

*3 AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output

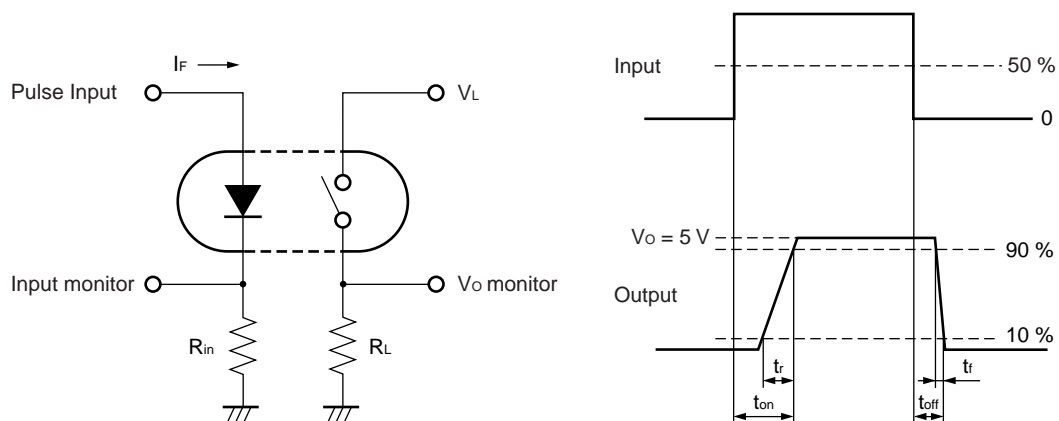
RECOMMENDED OPERATING CONDITIONS ($T_A = 25\text{ }^\circ\text{C}$)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
LED Operating Current	I_F	1	1.4	20	mA
LED Off Voltage	V_F	0		0.5	V

★ ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$)

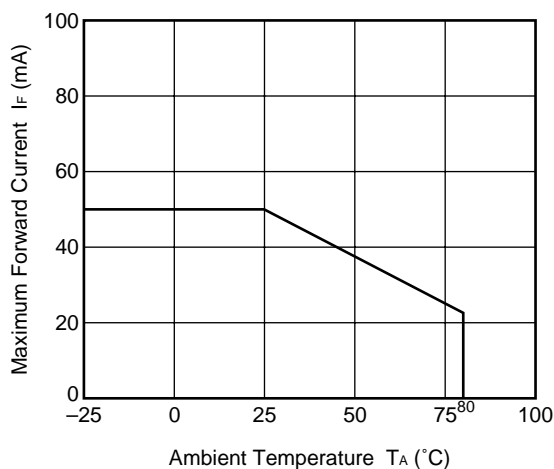
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V_F	$I_F = 1.4\text{ mA}$		1.2	1.4	V
	Reverse Current	I_R	$V_R = 5\text{ V}$			5.0	μA
MOS FET	Off-state Leakage Current	I_{Leak}	$V_D = 260\text{ V}$			1.0	μA
	Output Capacitance	C_{out}	$V_D = 0\text{ V}$, $f = 1\text{ MHz}$		122		pF/ch
Coupled	LED On-state Current	I_{Fon}	$I_L = 200\text{ mA}$			1.0	mA
	On-state Resistance	R_{on}	$I_F = 1.4\text{ mA}$, $I_L = 10\text{ mA}$		3.5	5.0	Ω
	Turn-on Time *1	t_{on}	$I_F = 1.4\text{ mA}$, $V_O = 60\text{ V}$, $R_L = 1.5\text{ k}\Omega$, $PW \geq 50\text{ ms}$		10	20	ms
	Turn-off Time *1	t_{off}			7.0	12	
	Rise Time	t_r		0.80			
	Fall Time	t_f		0.4			
	Isolation Resistance	$R_{\text{I-O}}$	$V_{\text{I-O}} = 1.0\text{ kV}_{\text{DC}}$	10^9			Ω
	Isolation Capacitance	$C_{\text{I-O}}$	$V = 0\text{ V}$, $f = 1\text{ MHz}$		0.4		pF/ch

*1 Test Circuit for Switching Time

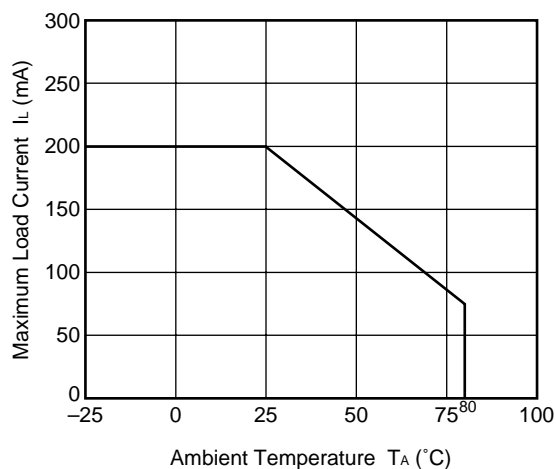


★ TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

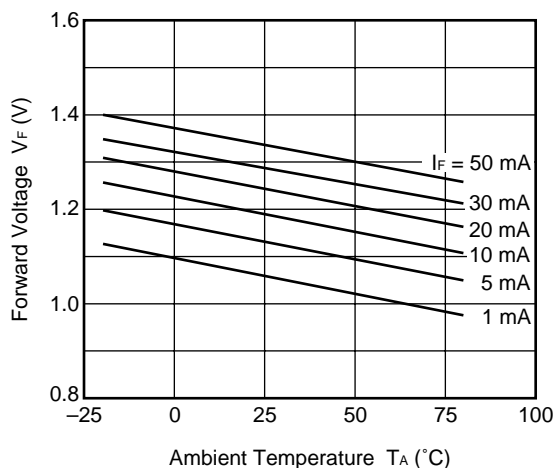
MAXIMUM FORWARD CURRENT vs. AMBIENT TEMPERATURE



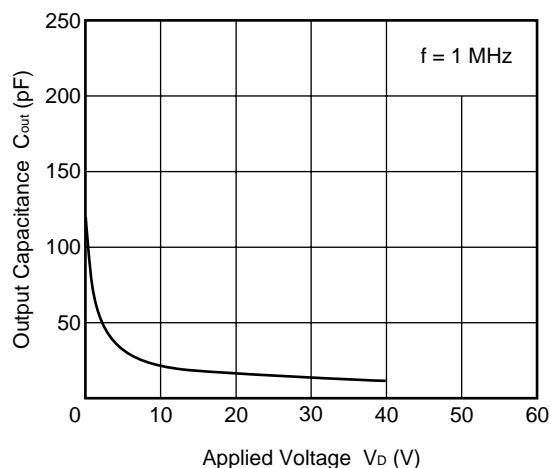
MAXIMUM LOAD CURRENT vs. AMBIENT TEMPERATURE



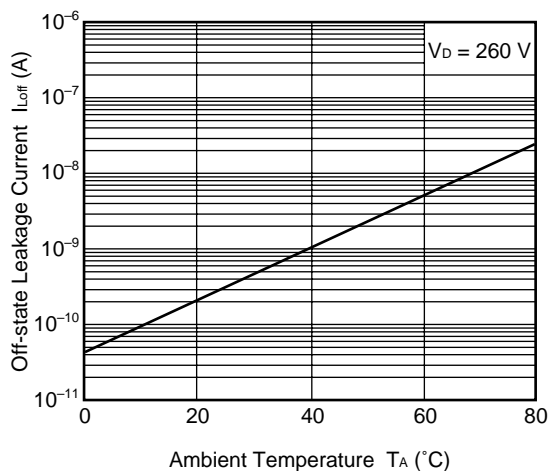
FORWARD VOLTAGE vs. AMBIENT TEMPERATURE



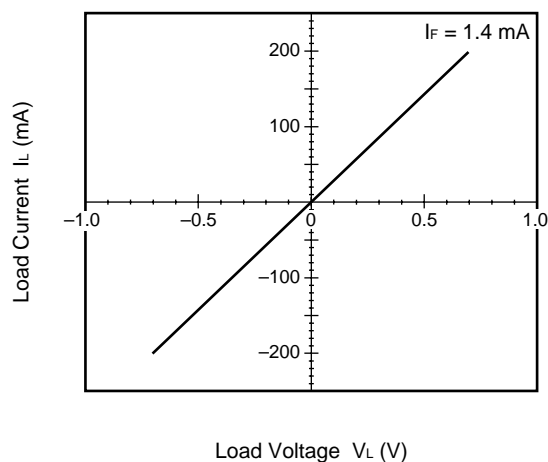
OUTPUT CAPACITANCE vs. APPLIED VOLTAGE



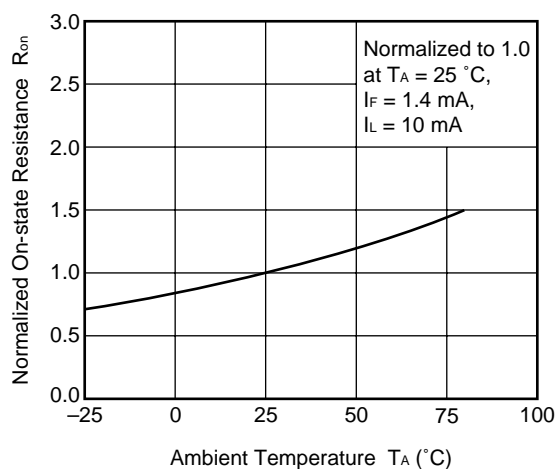
OFF-STATE LEAKAGE CURRENT vs. AMBIENT TEMPERATURE



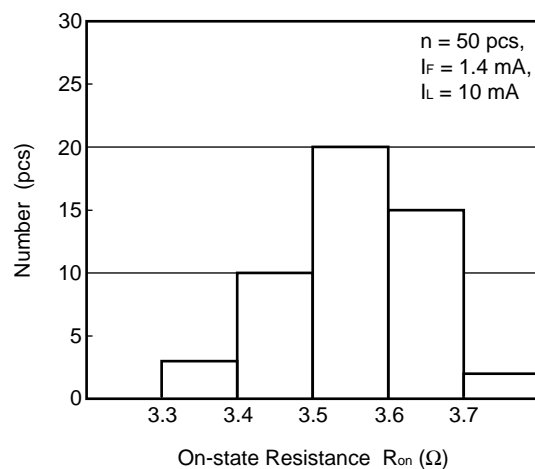
LOAD CURRENT vs. LOAD VOLTAGE



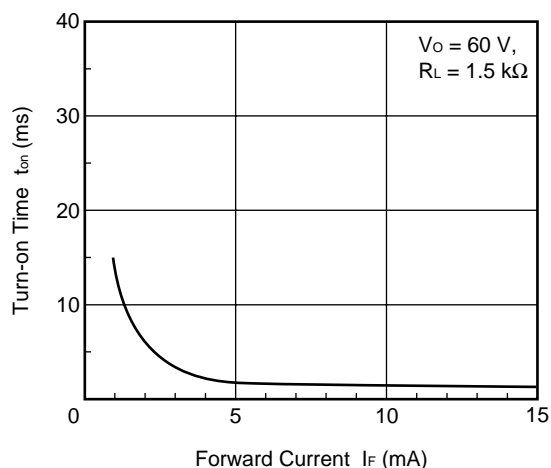
NORMALIZED ON-STATE RESISTANCE vs. AMBIENT TEMPERATURE



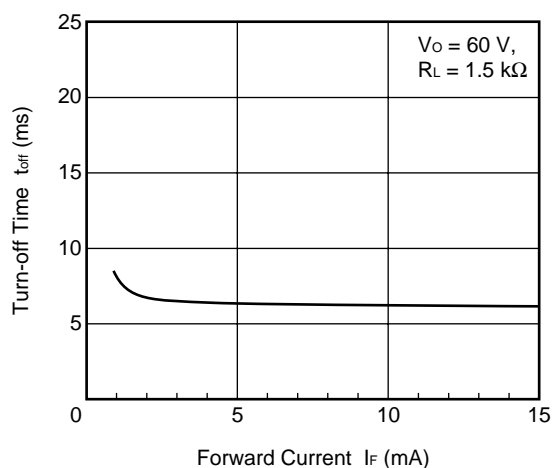
ON-STATE RESISTANCE DISTRIBUTION



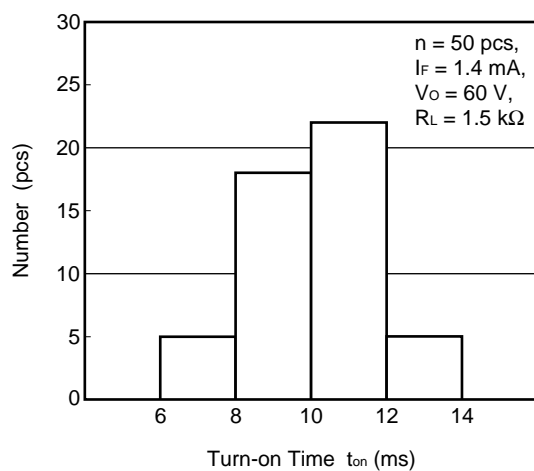
TURN-ON TIME vs. FORWARD CURRENT



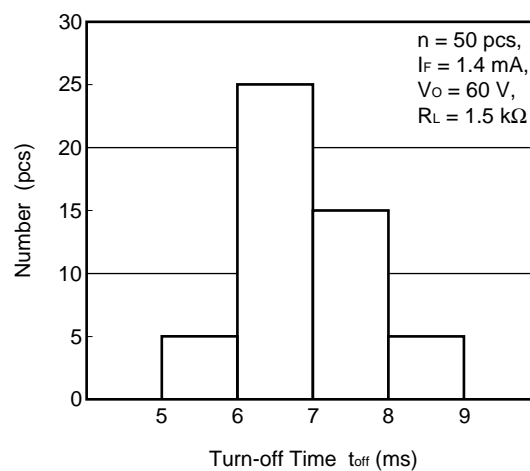
TURN-OFF TIME vs. FORWARD CURRENT



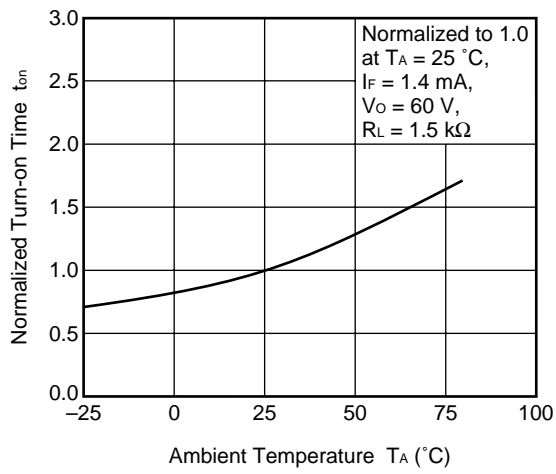
TURN-ON TIME DISTRIBUTION



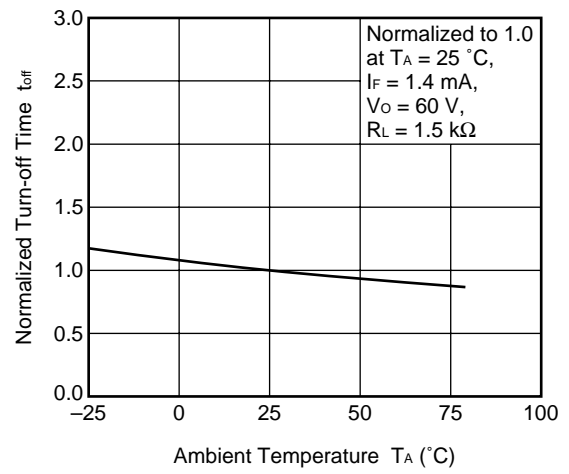
TURN-OFF TIME DISTRIBUTION



**NORMALIZED TURN-ON TIME vs.
AMBIENT TEMPERATURE**



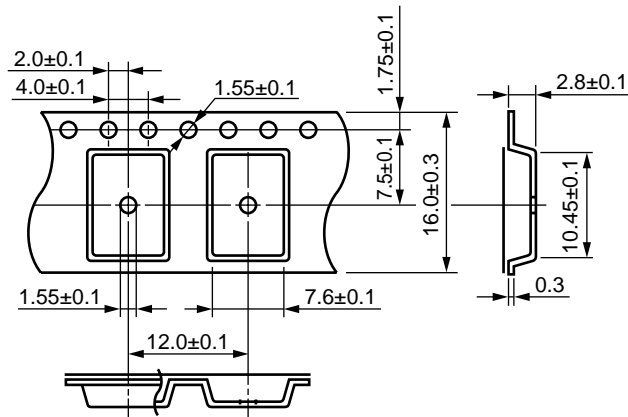
**NORMALIZED TURN-OFF TIME vs.
AMBIENT TEMPERATURE**



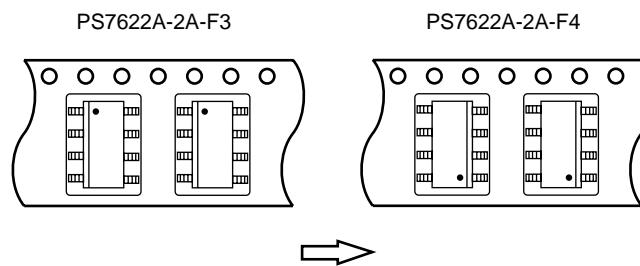
Remark The graphs indicate nominal characteristics.

★ TAPING SPECIFICATIONS (in millimeters)

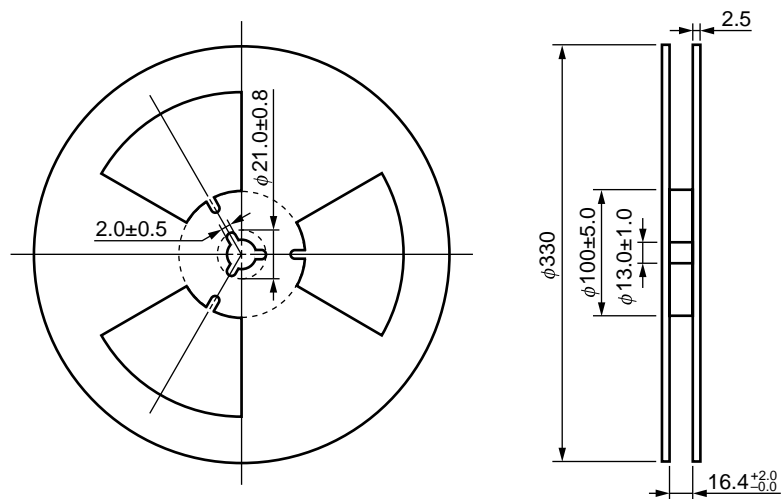
Outline and Dimensions (Tape)



Tape Direction



Outline and Dimensions (Reel)



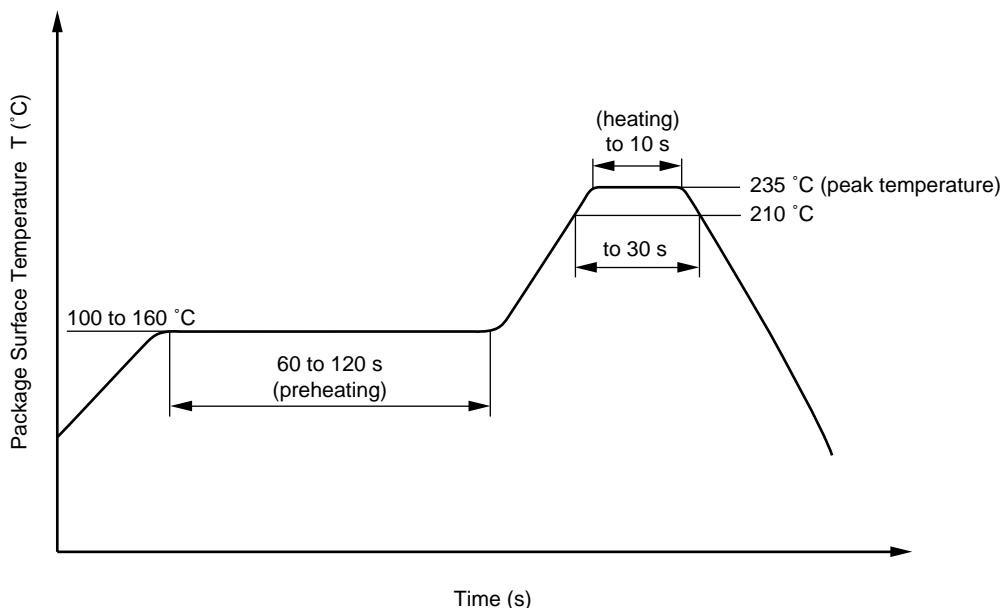
Packing: 1 500 pcs/reel

★ RECOMMENDED SOLDERING CONDITIONS

(1) Infrared reflow soldering

- Peak reflow temperature 235 °C or below (package surface temperature)
- Time of temperature higher than 210 °C 30 seconds or less
- Number of reflows Two
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

Recommended Temperature Profile of Infrared Reflow

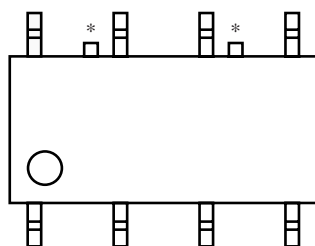


(2) Dip soldering

- Temperature 260 °C or below (molten solder temperature)
- Time 10 seconds or less
- Number of times One
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt % is recommended.)

(3) Cautions

- Fluxes
 - Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.



* : Portion of frame

[MEMO]

[MEMO]

CAUTION

Within this device there exists GaAs (Gallium Arsenide) material which is a harmful substance if ingested. Please do not under any circumstances break the hermetic seal.

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